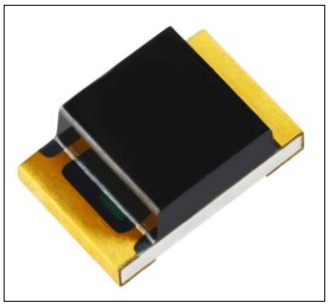
Standard Product Reference Sheet

VTPS1192HB−TR



Features

Package	Flat lens package, Photo transistor (Photo detector), Visible ray cut resin Outer Dimension 2.0 x 1.25 x 0.8mm (L x W x H)
Product features	・Equivalent to JEDEC level 3 (IPC/JEDEC J-STD-020D) ・Lead−free soldering compatible ・RoHS compliant

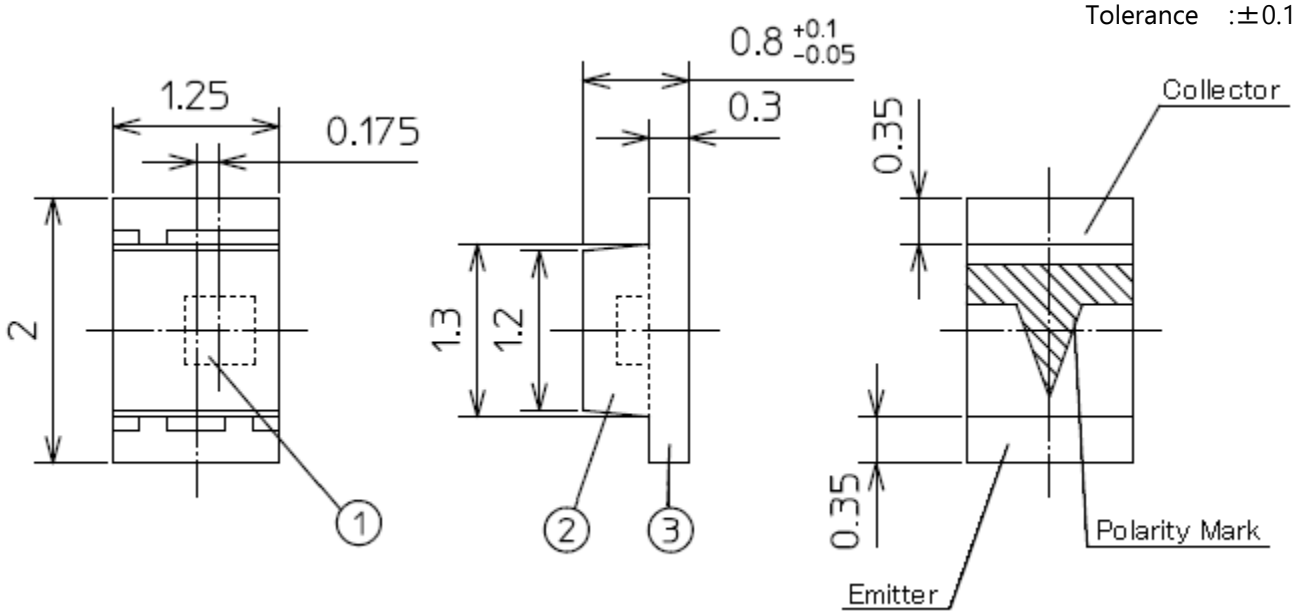
Recommended Applications

・Media disc detector for car audio, etc.

Outline Dimensions

VTPS1192HB−TR

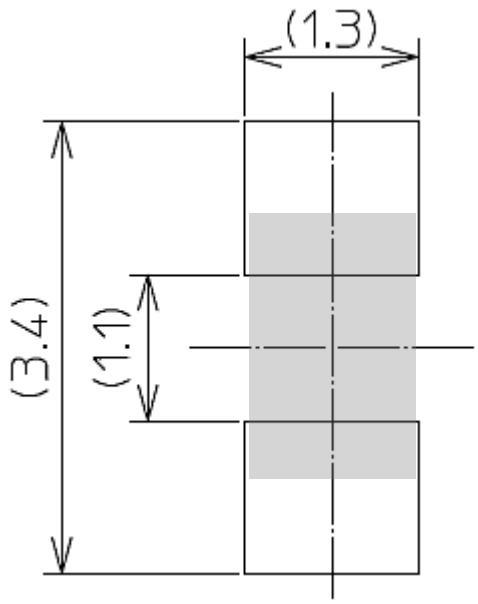
Unit :mm
Weight :2.84mg
Tolerance :±0.1



NO.	PART NAME	MATERIAL	QTY.
①	Photo Transistor	Si	1
②	Mold Resin	Epoxy Resin	1
③	Substrate	Glass Fabrics	1

Recommended Pad

Unit :mm



【 Absolute Maximum Ratings 】

(Ta=25℃)

ITEM	SYMBOL	MAXIMUM RATINGS	UNIT
Power Dissipation	Pc	75	mW
Collector-Emitter Voltage	V_{CEO}	12	V
Emitter-Collector Voltage	V_{ECO}	5	V
Collector Current	Ic	20	mA
Operating Temperature	T_{opr}	−40 ～ +85	℃
Storage Temperature	T_{stg}	−40 ～ +100	℃

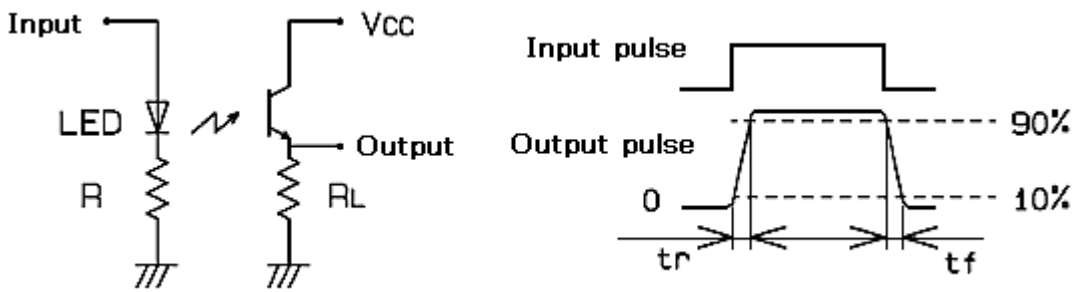
【 Electro-Optical Characteristics 】

(Ta=25℃)

ITEM		SYMBOL	CONDITIONS	MIN.	TYP.	MAX.	UNIT
Dark Current		I_{CEO}	V_{CEO} = 10V	-	-	0.1	μA
Photo Current		Ic	V_{CE} = 5V, ※1 Ee = 5mW/cm^2	0.45	1.30	2.27	mA
Peak Wavelength		λp	V_{CE} = 5V	-	900	-	nm
Collector-Emitter saturation voltage		$V_{ce(Sat)}$	Ic = 0.5mA, ※1 Ee = 10mW/cm^2	-	0.10	-	V
Response Time	Rise Time	tr	※2 V_{CE} = 10V, Ic = 2mA, R_L = 100Ω	-	1.8	-	μs
	Fall Time	tf		-	2.6	-	μs
Angle of half sensitivity		Δθ	Longitudinal direction	-	130	-	deg.
			Lterarl direction	-	120	-	deg.

※1 The illuminances refer unfiltered radiation of a tungsten filament lamp at a color temperature of 2,856K.

※2 Response time test circuit : as follows

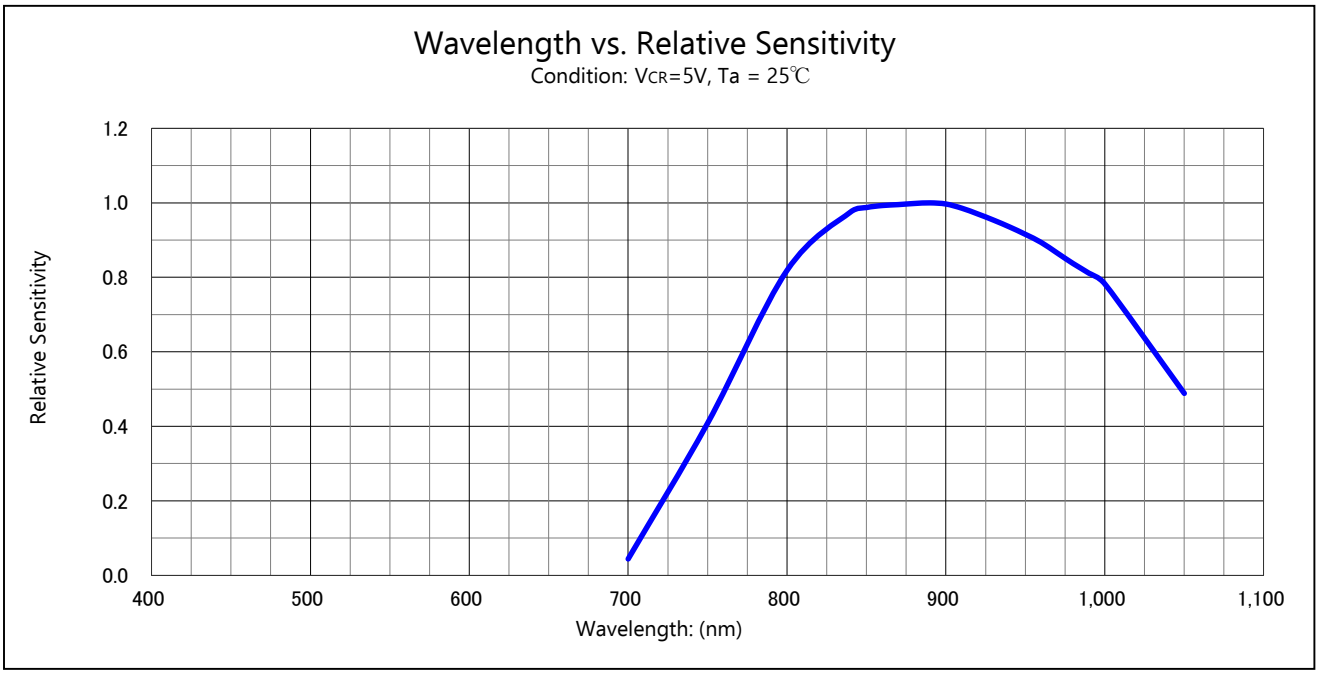


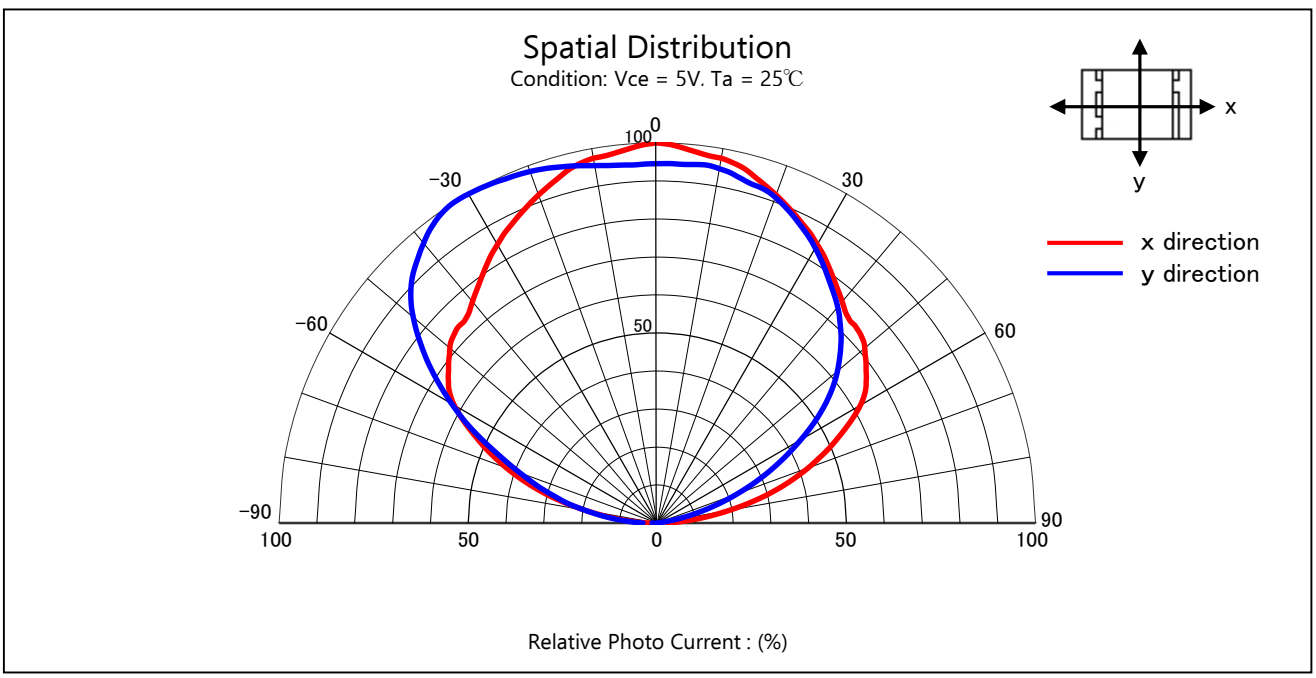
【 Sorting for Photo current 】

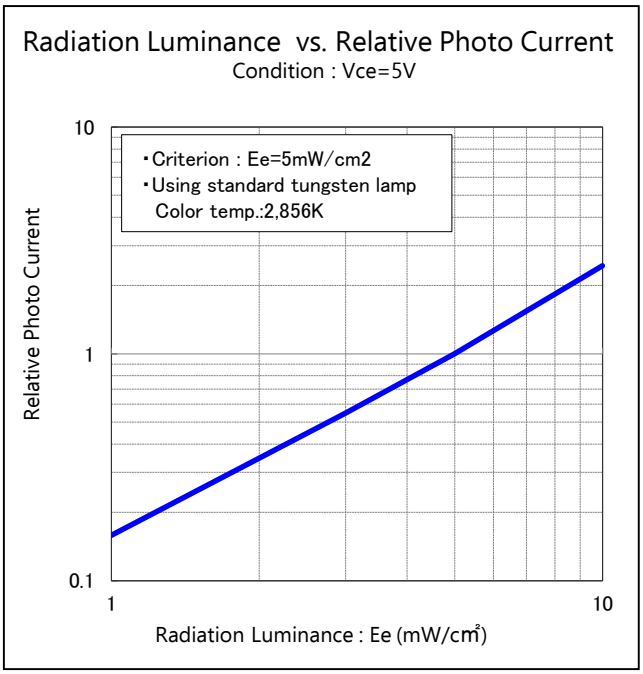
Photo Transistors shall be sorted out into the following ranks.

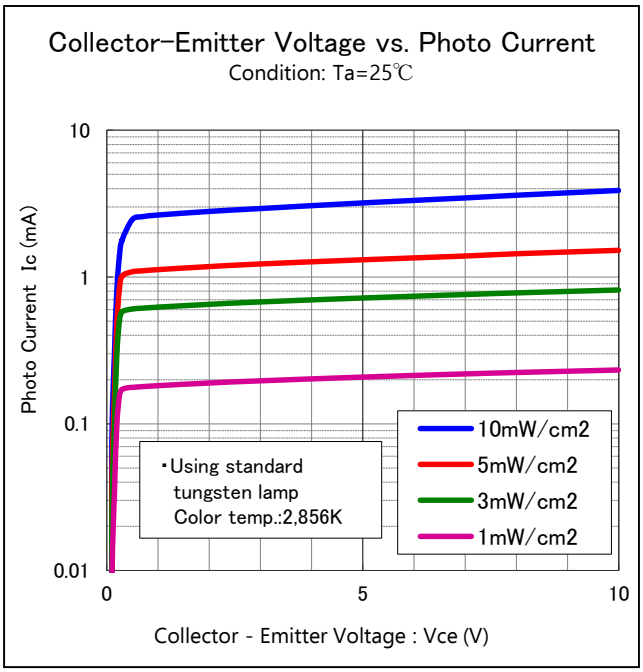
The each shipping lot shall consist of mixed ranks (VA to VG), and the quantity of this product in each rank can not be specified.

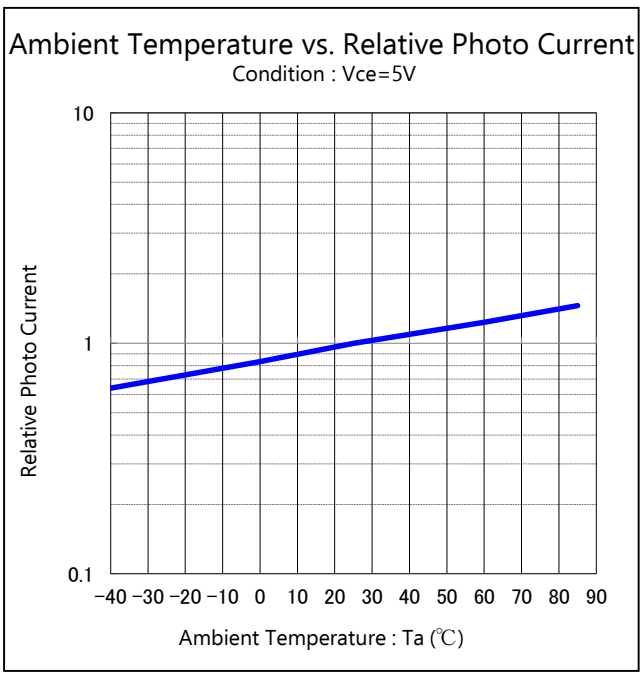
Rank	Photo Current Ic(mA)		Conditions
	MIN.	MAX.	
VA	0.45	0.57	V_{CE}=5V Ee=5mW/cm² Ta=25℃
VB	0.57	0.71	
VC	0.71	0.90	
VD	0.90	1.13	
VE	1.13	1.43	
VF	1.43	1.80	
VG	1.80	2.27	

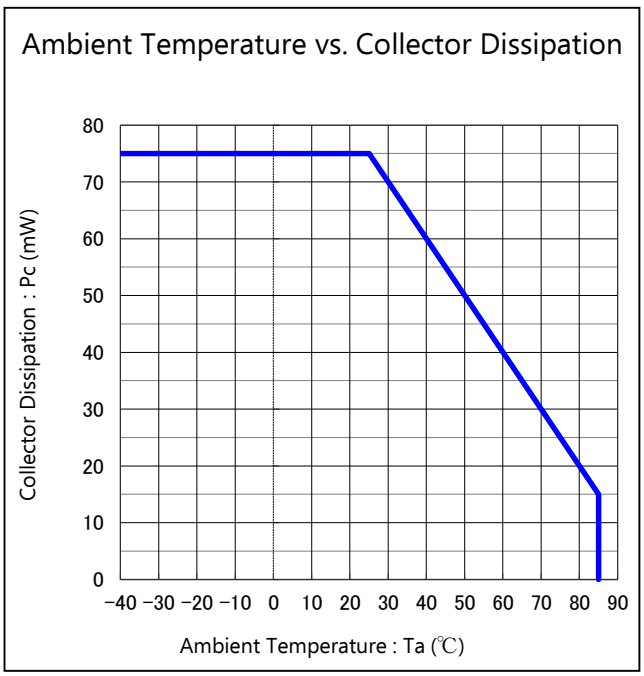

Wavelength vs. Relative Sensitivity
Condition: VCR=5V, Ta = 25℃
Relative Sensitivity
1.2
1.0
0.8
0.6
0.4
0.2
0.0
400
500
600
700
800
900
1,000
1,100
Wavelength: (nm)

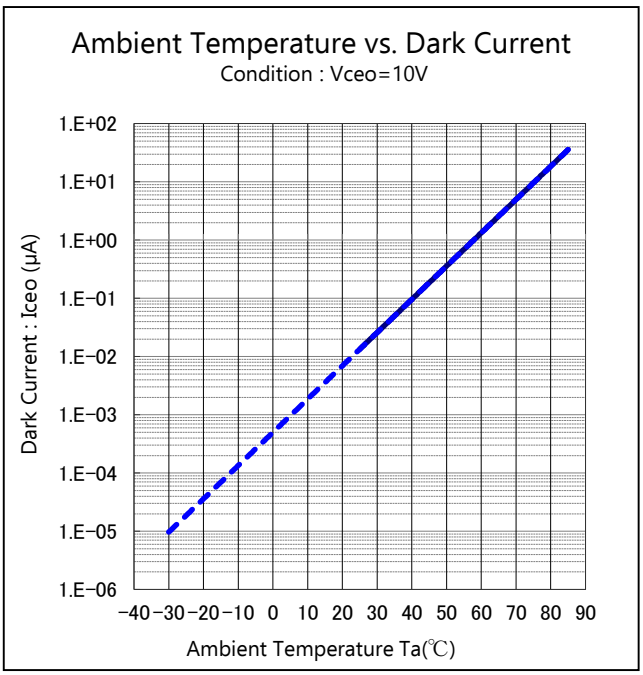

Spatial Distribution
Condition: Vce = 5V. Ta = 25℃
0
100
−30
30
−60
60
50
−90
90
100
50
0
50
100
x
y
x direction
y direction
Relative Photo Current : (%)


Radiation Luminance vs. Relative Photo Current
Condition : Vce=5V
・Criterion : Ee=5mW/cm2
・Using standard tungsten lamp
Color temp.:2,856K
Relative Photo Current
10
1
0.1
1
10
Radiation Luminance : Ee (mW/cm²)


Collector-Emitter Voltage vs. Photo Current
Condition: Ta=25℃
Photo Current Ic (mA)
10
1
0.1
0.01
0
5
10
・Using standard
tungsten lamp
Color temp.:2,856K
10mW/cm2
5mW/cm2
3mW/cm2
1mW/cm2
Collector - Emitter Voltage : Vce (V)


Ambient Temperature vs. Relative Photo Current
Condition : Vce=5V
Relative Photo Current
10
1
0.1
-40 -30 -20 -10 0 10 20 30 40 50 60 70 80 90
Ambient Temperature : Ta (℃)


Ambient Temperature vs. Collector Dissipation
Collector Dissipation : Pc (mW)
80
70
60
50
40
30
20
10
0
-40 -30 -20 -10 0 10 20 30 40 50 60 70 80 90
Ambient Temperature : Ta (℃)


Ambient Temperature vs. Dark Current
Condition : Vceo=10V
Dark Current : Iceo (μA)
1.E+02
1.E+01
1.E+00
1.E−01
1.E−02
1.E−03
1.E−04
1.E−05
1.E−06
−40 −30 −20 −10 0 10 20 30 40 50 60 70 80 90
Ambient Temperature Ta(℃)

【Soldering Precaution】

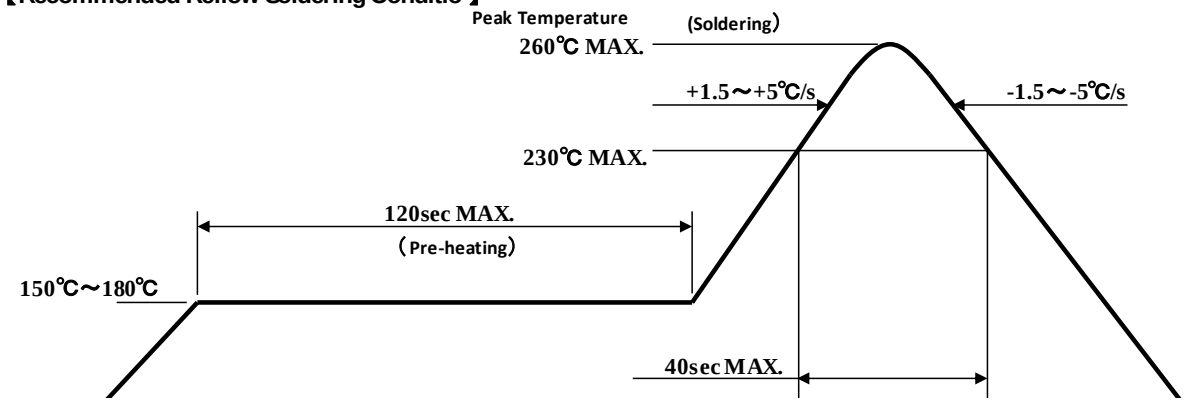
(acc.to EIAJ-4701/300)

1. Heat stress during soldering will influence the reliability of Photo detectors, however that effect will vary on heating method. Also, if components of varying shape are soldered together, it is recommended to set the soldering pad temperature according to the component most vulnerable to heat (e.g., surface mount device).

2. Photo detector parts including the resin are not stable immediately after soldering (when they are not at room temperature), any mechanical stress may cause damage to the product. Please avoid such stress after soldering, especially stacking of the boards which may cause the boards to warp and any other types of friction with hard materials.

3. Recommended temperature profile for the Reflow soldering is listed as the temperature of the resin surface. Temperature distribution varies on heating method, PCB material, other components in the assembly, and mounting density .
   Please do not repeat the heating process in Reflow process more than twice.

【Recommended Reflow Soldering Conditio 】



Note 1 Temperature Profile for the reflow should be set to the surface temperature of resin which is on the top of Photo detector. This should be the maximum temperature for soldering. Lowering the heating temperature and decreasing heating time is very effective in achieving higher reliability.

Note 2 The reflow soldering process should be done up to twice(2 times Max). When second process is performed, interval between first and second process should be as short as possible to prevent absorption of moisture to resin of Photo detector. The second soldering process should not be done until Photo detectors have returned to room temperature (by nature-cooling) after first soldering process.

4. If soldering manually, Stanley recommends using a soldering iron equipped with temperature control. During the actual soldering process, make sure that the soldering iron never touches the Photo detector itself, and avoid the Photo detector's electrode heating temperature reaching above the heating temperature of the solder pad. All repairs must be performed only once in the same spot, and please avoid reusing components.

5. In soldering process, immediately after iron tip is cleaned, please make sure that the soldering iron reaches the appropriate temperature, before using. Also, please avoid applying any types of pressure to the soldered components before the solder has been cooPhoto detector and hardened, as it may deteriorate solder performance and solder quality.

【Recommended Manual Soldering Condition】

Temperature of Iron Tip	350℃MAX.
Soldering Duration, Time	3sec.Max.,1 time

6. When using adhesive material for tentative fixatives, thermosetting resin or Ultraviolet radiation (UV) setting resin with heat shall be recommended. 《The curing condition, Temperature:150℃Max./Time:120sec.Max.》

7. Isopropyl alcohol is recommended for cleaning. Some chemicals, including Freon substitute detergent could corrode the lens or the casing surface, which cause discoloration, cloud, crack and so on. Please review the reference chart below for cleaning. If water is used to clean (including the final cleaning process), please use pure water (not tap water), and completely dry the component before using.

Chemical	Adaptability
Ethyl Alcohol	○
Isopropyl Alcohol	○
Pure Water	○
Trichloroethylene	×
Chlorothene	×
Acetone	×
Thinner	×

【Other Precautions】

1. This product has semiconductor characteristics and are designed to ensure high reliability. However, the performance may vary depending on usage conditions.

2. Absolute Maximum Ratings are set to prevent Photo detector from failing due to excess stress(temperature, current, voltage, etc.). Usage conditions must not exceed the ratings for a moment, nor do reach one item of absolute maximum ratings simultaneously.

3. In order to ensure high reliability from Photo detector, variable factors that arise in actual usage conditions should be taken it to account for designing. (Derating of TYP., MAX Forward Voltage, etc.)

4. Please insert Protective Resistors into the circuit in order to stabilize Photo detector operation and to prevent the device from igniting due to excess current.

5. Please check the actual performance in the assembly because the Specification Sheets are described for Photo detector device only.

6. Please refrain from looking directly at the light source of Photo detector at high output, as it may harm your vision.

7. The products are designed to operate without failure in recommended usage conditions. However, please take the necessary precautions to prevent fire, injury, and other damages should any malfunction or failure arise.

8. The products are manufactured to be used for ordinary electronic equipment. Please contact our sales staff beforehand when exceptional quality and reliability are required, and the failure or malfunction of the products might directly jeopardize life or health (such as for airplanes, aerospace, transport equipment, medical applications, nuclear reactor control systems and so on).

9. The formal specification sheets shall be valid only by exchange of documents signed by both parties.

This product is baked (moisture removal) before packaging, and is shipped in moisture-proof packaging (as shown below) to minimize moisture absorption during transportation and storage. However, with regard to storing the products, Stanley recommends the use of dry-box under the following conditions is recommended. Moisture-proof bag as the packaging is made of anti-static material but packaging box is not.

【Recommended Storage Condition / Products Warranty Period 】

Temperature	+5～30℃
Humidity	Under 70%

In the case of the package unopened , 6 months under【 Recommended Storage Condition 】.
Please avoid rapid transition from low temp. condition to high temp. condition
and storage in corroding and dusty environment.

【Time elapsed after Package Opening】

The package should not be opened until immediately prior to its use, and please keep the time frame between package opening and soldering which is **【maximum 168h】**.
If the device needs to be soldered twice, both soldering operations must be completed within the 168h.

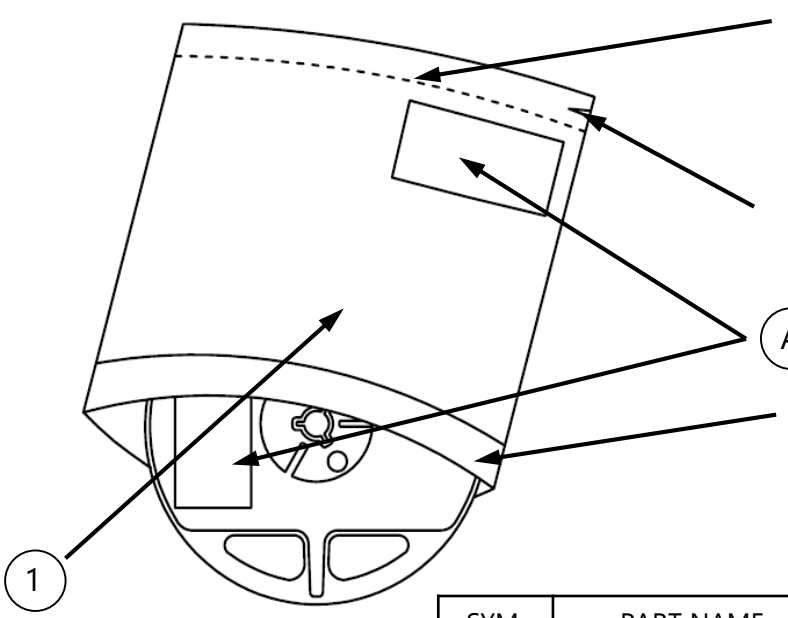
If any components should remain unused, please reseal the package and store them under the conditions described in the【 Recommended Storage Condition 】above.

This product must be required to perform baking process (moisture removal) for **at least 10h and not exceed for 12h** at 60±5 degrees Celsius if following conditions apply.
1. In the case of silica gel (blue) which indicates the moisture level within the package, changes or loses its
   blue color.
2. In the case of time passes for 168h after the package is opened once.

Baking process should be performed after Photo detector having been taken out of the package.

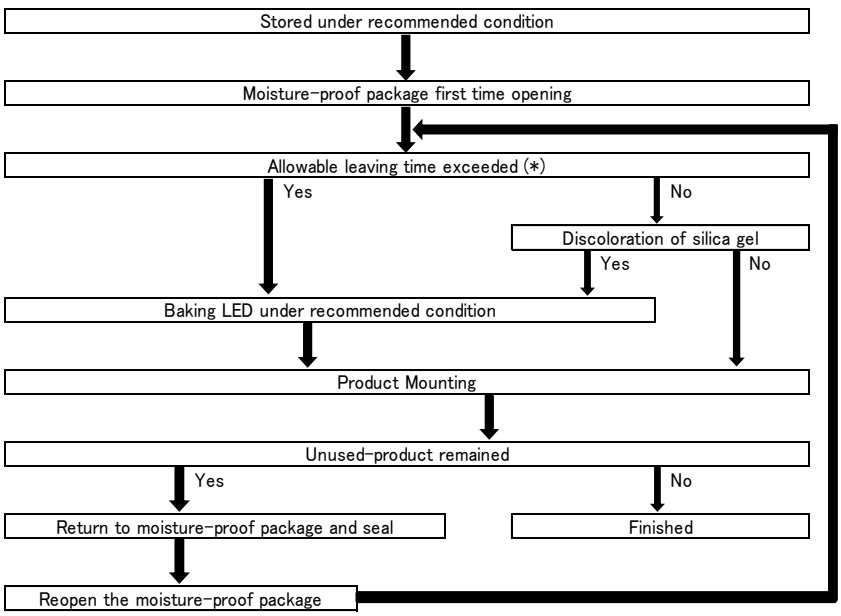
Baking may be performed in the tape-reel form , however if it is performed with the reel stacked over one another, it may cause deformation of the reels and taping materials and later obstruct mounting. Please handle only once it has returned to room temperature. Provided that, baking process shall be 2 times MAX.

【Moisture-proof Packaging Specification】



SYM.	PART NAME	MATAL.	REMARKS
①	Moisture-proof bag with Aluminum layer	PET+Al+PE	with ESD protection

【Flow Chart-package Opening to Mounting】



Allowable leaving time means the maximum allowable leaving time after opening package, which depends on each Photo detector type.
The allowable leaving time should be calculated form the first opening of package to the time when soldering process is finished.
When judging if the allowable leaving time has exceeded or not, please subtract the soldering time. The allowable leaving time after reopening should be calculated form the first opening of package, or from the time when baking process is finished.

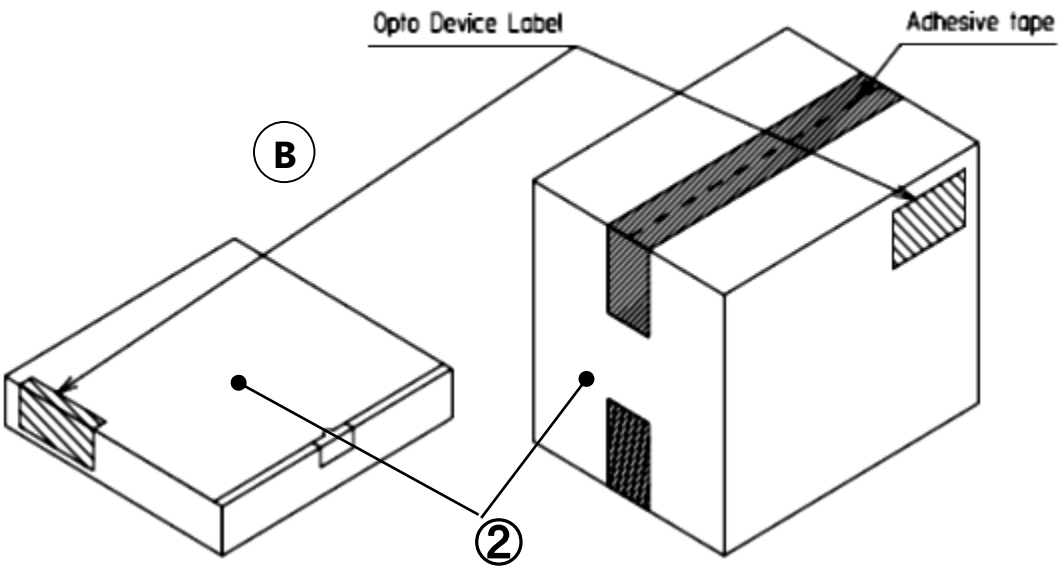
【 Packing box 】

(RoHS・ELV Compliant)

Box TYPE	Outline dimension L × W × H (mm)	Capacity of the box
Type A	280 × 265 × 45	3 reels
Type B	310 × 235 × 265	15 reels
Type C	440 × 310 × 265	30 reels

The above measure is all the reference value.

The box is selected out of the above table by shipping quantity.



Type A
Material / box : Cardboard C5BF

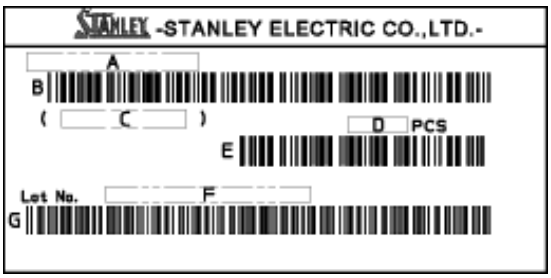
Type B,C
Material / box : Cardboard K5AF
Partition : Cardboard K5BF

No.	PART NAME	MATERIAL	REMARKS
②	Packing Box	Corrugated Cardboard	without ESD protection

【Label Specification】

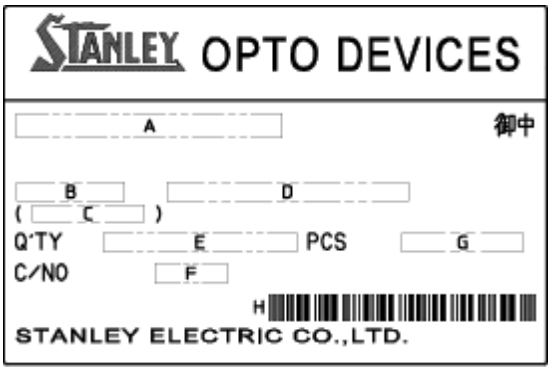
(acc.to JIS-X0503(Code-39))

(A) Product Label



A. Parts number
B. Bar-code for parts number
C. Parts code (In-house identification code for each parts numbe
D. Packed parts quantity
E. Bar-Code for packed parts quantity
F. Lot number & Rank
(Refer to Lot Number Notational System for details)
G. Bar-Code for Lot number & Rank

(B) Opto Device Label

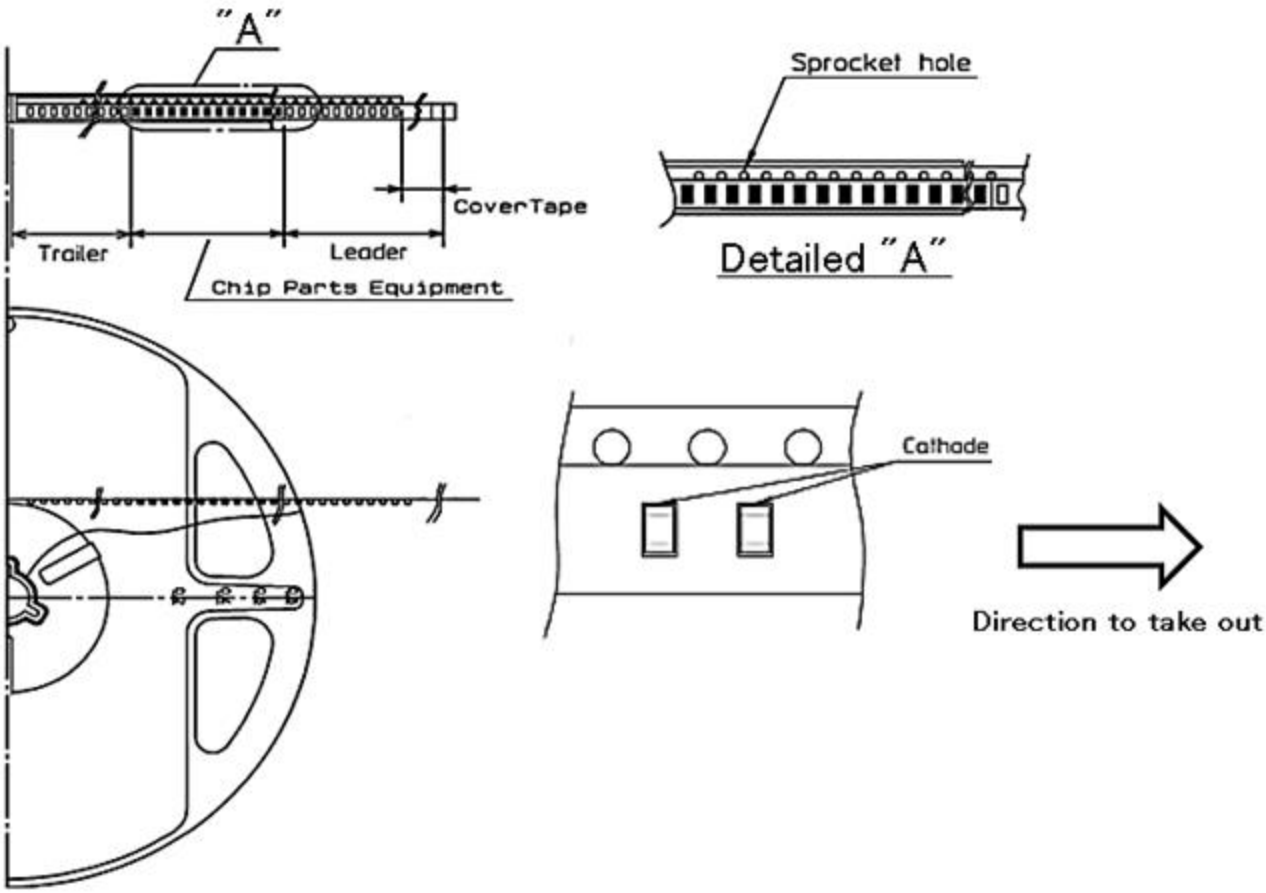


A. Customer Name
B. Parts Type
C. Parts Code
D. Parts Number
E. Packed Parts Quantity
F. Carton Number
G. Shipping Date
H. Bar-Code for In-house identification Number

<Remark> Bar-code font : acc.to Code-39(JIX0503)

(acc.to ; JIS-C0806-03)

1. Appearance



Note

"-TR" means Cathode Side of Photo detectors should be placed on the sprocket-hole side.

Items		Specifications	Remarks
Leader area	Cover-tape	Cover-tape shall be longer than 200mm without carrier-tape	The end of cover-tape shall be held with adhesive tape.
	Carrier-tape	Empty pocket shall be more than 10 pieces.	Please refer to the above figure for Taping & reel orientation .
Trailer area		Empty pocket shall be more than 15 pieces.	The end of taping shall be inserted into a slit of the hub.

【Qty. per Reel】

4,000parts/reel
Minimum Qty. per reel might be 500 parts when getting less than 4,000 parts. In such case, parts of 500-unit-qty. shall be packed in a reel and the qty. shall be identified on the label.

【Mechanical strength】

Cover-tape adhesive strength shall be 0.1～1.0N (An angle between carrier-tape and cover-tape shall be170 deg.) Both tapes shall be so sealed that the contained parts will not come out from the tape when it is bent at a radius of 15mm.

【Others】

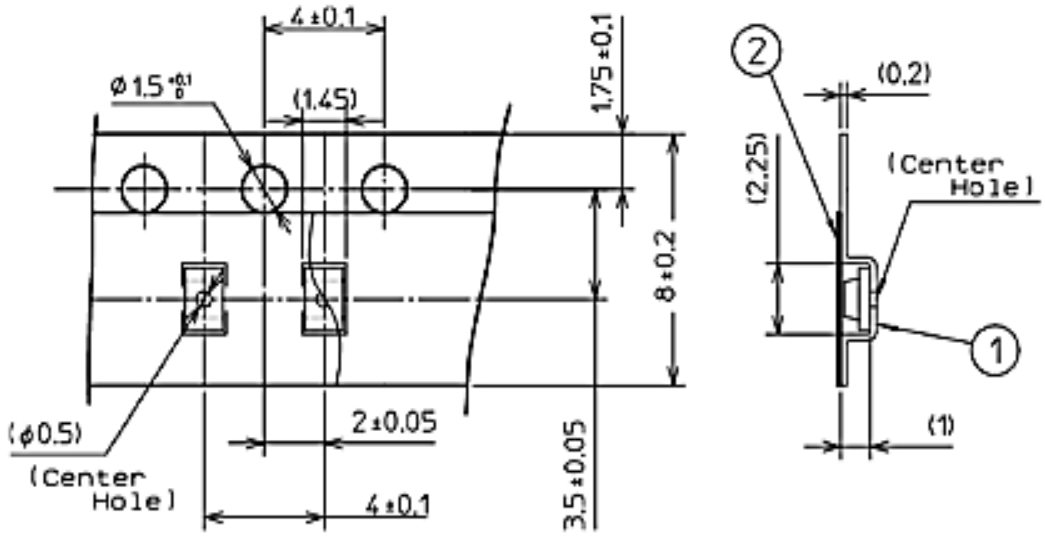
Reversed-orientation, Up-side down placing, side placing and out of spec. parts mix shall not be held. Max qty. of empty pocket per reel shall be defined as follows.

Qty./reel	Max. qty. of empty pocket	Remark
500	1	-
1,000	1	-
1,500	1	-
2,000	2	No continuance
2,500	2	No continuance
3,000	3	No continuance
4,000	4	No continuance

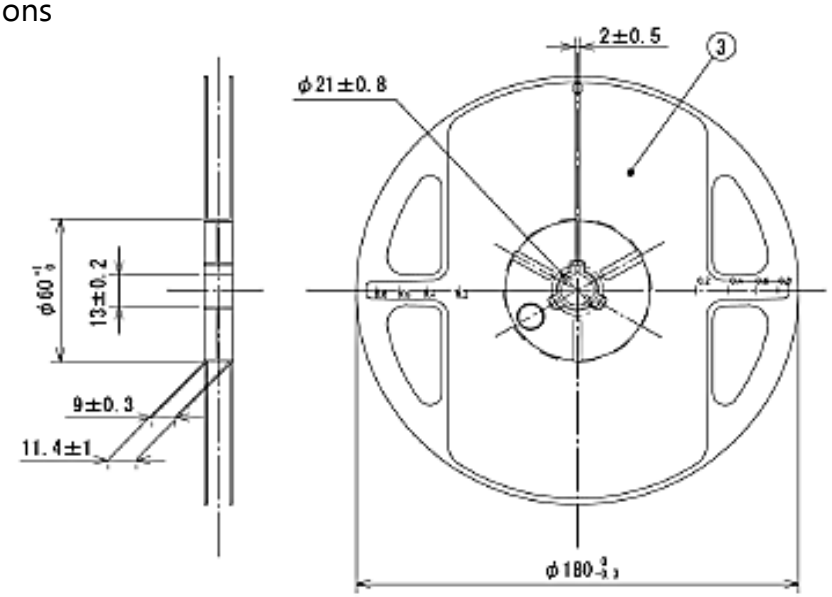
Unit : mm

(acc.to ; JIS-C0806-03)

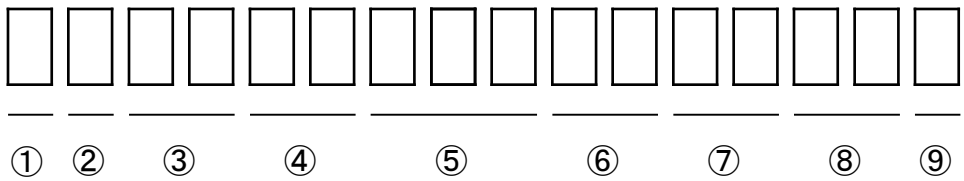
5. Taping Dimensions



6. Reel Dimensions



NO.	PART NAME	REMARKS
①	Carrier-tape	Conductive Grade
②	Cover-tape	Anti-Static Grade
③	Carrier-reel	Anti-Static Grade



① - 1digit : Production Location (Mark identify alphabet)

② - 1digit : Production Year (Last digit of production Year 2009→9,2010→0,2011→1,･･･)

③ - 2digits : Production Month (Jan. to Sep. ,should be 01,02,03,･････)

④ - 2digits : Production Date

⑤ - 3digits : Serial Number

⑥ - 2digits : Tape and Reel following Number

⑦ - 2digits : Luminous Intensity Rank.

(If luminous intensity rank is 1 digit, "-" shall be dashed on the place for the second digit.
If there is no identified intensity rank, "- -" is used to indicate.)

⑧ - 2digits : Chromaticity Rank

(If chromaticity rank is 1 digit, "-" shall be dashed on the place for the second digit.
If there is no identified intensity rank, "- -" is used to indicate.)

⑨ - 1digit : Option Rank (Stanley normally print "-" to indicate)

Correspondence to RoHS・ELV instruction VTPS1192HB−TR

This product is in compliance with RoHS・ELV.

Prohibition substance and it's criteria value of RoHS・ELV are as follows.

・RoHS instruction ..... Refer to following (1)～(6).
・ELV instruction ..... Refer to following (1)～(4).

	Substance Group Name	Criteria Value
(1)	Lead and its compounds	1,000ppm Max
(2)	Cadmium and its compounds	100ppm Max
(3)	Mercury and its compounds	1,000ppm Max
(4)	Hexavalent chromium	1,000ppm Max
(5)	PBB	1,000ppm Max
(6)	PBDE	1,000ppm Max

Reliability Testing Condition VTPS1192HB-TR

Test Item	Test Condition
Endurance Operational Test	Ta=25℃, 1,000h , V_{CE}=12V
Humidity-Resistance Operational Test	Ta=60℃, RH=90% , 1,000h , V_{CE}=5V
High Temperature Operational Test	Ta=85℃, 1,000h , V_{CE}=5V
Low Temperature Operational Test	Ta=-30℃, 1,000h , V_{CE}=5V
Heat Cycle Test	Storage Temp. Min, value(15min.)～ Storage Temp. Max,value(15min.) 1,000cycle
High Temperature Shelf Test	Ta=Storage Temp. Max., value t=1,000h
Low Temperature Shelf Test	Ta=Storage Temp. Min., value t=1,000h
Reflow Resistance Test	Moisture Soak :Ta=30℃, RH=70%, 168h Preheating : 150～180℃ 120sec. Max. Soldering : 230～260℃ 40sec. Max.

Failure Criteria

Item	Symbol	Test Condition	Failure Criteria
Dark current	I_D	V_{CE}= 5V	I_D < 0.1μA
Photo current	Ic	V_{CE}= 5V , Ee = 5mW/cm²	Initial value × 0.7 < Ic < Initial value × 1.3
Cosmetic appearance	—	—	Notable, discoloration, deformation and cracking

Special Notice to Customers Using the Products and Technical Information Shown in This Data Sheet

1) The technical information shown in the data sheets are limited to the typical characteristics and circuit examples of the referenced products. It does not constitute the warranting of industrial property nor the granting of any license.

2) For the purpose of product improvement, the specifications, characteristics and technical data described in the data sheets are subject to change without prior notice. Therefore it is recommended that the most updated specifications be used in your design.

3) When using the products described in the data sheets, please adhere to the maximum ratings for operating voltage, heat dissipation characteristics, and other precautions for use. We are not responsible for any damage which may occur if these specifications are exceeded.

4) The products that have been described to this catalog are manufactured so that they will be used for the electrical instrument of the benchmark (OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument).
The application of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. needs a high reliability and safety, and the breakdown and the wrong operation might influence the life or the human body. Please consult us beforehand if you plan to use our product for the usages of aircrafts, space borne application, transportation equipment, medical equipment and nuclear power control equipment, etc. except OA equipment, telecommunications equipment, AV machine, home appliance and measuring instrument.

5) In order to export the products or technologies described in this data sheet which are under the "Foreign Exchange and Foreign Trade Control Law," it is necessary to first obtain an export permit from the Japanese government.

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